

| Moisture sensitivity level: Level 1

FEATURES

| Surface Mounting Design 8.3*8.3*6.0mm | High Current Handling Capability 20000A @ 8/20 µs | Low Capacitance and Insertion Loss | Quick Response and Long Service Life



8.3*8.3*6.0mm



APPLICATION INFORMATION

Communication equipment.
Repeaters, Modems
Telephone Interface,Line cards.
Data communication equipment.

AGENCY APPROVALS

lcon	Solderability		
RoHS	Compliance with 2011/65/EU		
HF	Compliance with IEC61249-2-21:2003		
®	Mean lead free		
<i>1</i> R °	UL Certificated E505857		

PRODUCT CHARACTERISTICS

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



ELECTRICAL PARAMETER

Parameter	Condition	Rating	
DC Spark-over Voltage 1)	100V/s	640-960	
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤1500	V
impuise spair-over voltage	At 1kV/μs	Typical values of distribution ≤1450	
Discharge Current (8/20us) 2)	10 times	20	
AC Discharge Current	50Hz, 1S	20	А
Minimum Insulation Resistance	Test Voltage DC=250V	1	GΩ
Max. Capacitance 1MHz	V _{DC} =0.5V	1.5	
Operating and Storage Temperature		-40~125	°C

¹⁾ In ionized mode

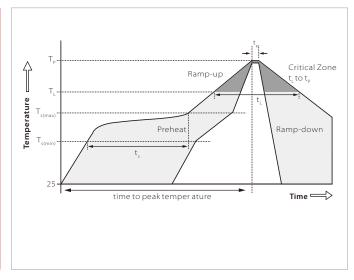
ENVIRONMENTAL RELIABILITY CHARACTERISTICS

Testing items	Technical standards	
High Temperature Storage Test	Temperature: 85°C ; Time:2H	
Low Temperature Storage Test	Temperature: -40°C ; Time:2H	
Vibration	Frequency: 10-500Hz; Amplitude: 0.15mm; Time:45min	
Resistance of soldering heat	Temperature: 260±5°C; Time of dip soldering: 10s, 1time	

NOTE: Up-screen program can be specified by customer's request via contacting Semiware service

REFLOW PROFILE

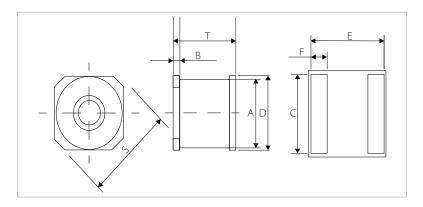
Reflow Condition		Lead-free assembly	
	Temperature Min	150°C	
Pre Heat	Temperature Max	200°C	
	Time(min to max)	60-180 secs	
Average ramp up rate (Liquidus)Temp (T_L) to peak T_s (max)to T_L - Ramp-up Rate		3°C/second max	
Reflow	Temperature (T _L) (Liquidus)	217℃	
Kellow	Temperature (T_L)	60-150 seconds	
PeakTemperature (T _p)		260+0/-5°C	
Time within 5°C of actual peak Temperature (tp)		~10 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T,)		8 minutes max.	
Do not exceed		260°C	



²⁾ Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21

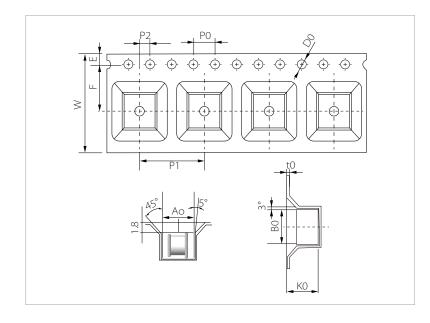


DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm	
А	8.0±0.2	
В	0.5±0.1	
С	9.0	
D	8.3±0.2	
Е	6.7	
F	1.2	
Т	6.0±0.25	
S	9.0±0.4	

PACKAGE REEL INFORMATION



Ref.	mm
W	16.0±0.3
PO	4.0±0.1
P1	12.0±0.1
P2	2.0±0.1
D0	1.55±0.05
E	1.75±0.1
F	7.5±0.1
A0	6.35±0.1
K0	6.55±0.1
ВО	8.65±0.1
tO	0.5±0.1

ORDERING INFORMATION

Part Number	Size	Marking	QTY/Reel	Reel Size
SG2R08B800A	8.3*8.3*6.0mm	⅓ SG800 <u>08</u>	600	13″



Headquarters

No.3387 Shendu Road Pujiang I&E Park Minhang Shanghai China 201000

Hotline

400-021-5756

Web

Https://www.semiware.com

Sales Center

Tel: 86-21-3463-7458 Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001 Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654 Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172 Ext: 8868 Email: cs03@semiware.com

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